

your BEST camera module partner

# JAL-OV8858-E06B V2.0

# OmniVision OV8858 MIPI Interfaccia Messa a fuoco automatica 8MP Modulo telecamera



Modulo telecamera n.	JAL-OV8858-E06B V2.0
Sensore d'immagine	OV8858
EFL	2.94 mm
F.NO	2.4
Pixel	3264 x 2448
Vista ad angolo	75°
Tipo di lente	1/4 pollice
Dimensioni dell'obiettivo	8.5 x 8.5 x 5.36 mm
Dimensione del modulo	
Tipo di modulo	Messa a fuoco automatica
Interfaccia	MIPI



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# OV8858 8MP product brief





available in a lead-free package

# Cost-Effective 1/4-Inch 8-Megapixel Image Sensor with Video-in-Video Support for Mainstream Mobile Devices

OmniVision's OV8858 is a 1/4-inch 8-megapixel PureCel™ image sensor for the rapidly growing mainstream smartphone and tablet market. The compact and costeffective OV8858 sensor delivers dramatically reduced power consumption and best-in-class performance, making it a highly competitive solution for the nextgeneration of mobile devices.

Compared to OmniVision's previous-generation 1/4-inch 8-megapixel sensor, the OV8858 delivers a number of performance enhancements, including dramatically improved full-well capacity (FWC) and sensitivity for enhanced high- and low-light performance. It also offers a significant reduction in power consumption and form factor.

The sensor also features OmniVision's Video-in-Video (ViV<sup>™</sup>) technology, which stitches together images from the front- and rear-cameras, applies enhancements such as independent lens correction and color compensation, and sends the combined image to the host ISP. In ViV mode, users can capture a portrait scene perfectly alongside their own face, record video while narrating for high quality video blogging, or utilize the feature for video conferencing. This is made possible by a special input MIPI receiver on the OV8858 that can accept image data from a wide range of OmniVision image sensors designed for front-facing applications of 2-megapixel and below, thus saving a camera port on the host ISP.

The OV8858 supports an active array of 3264 x 2448 pixels (8-megapixel) operating at 30 frames per second (fps) for zero shutter lag, enabling high-speed photography. The sensor is capable of recording 1080p high definition (HD) video at 60 fps, or 720p HD video at 90 fps, each with additional pixels for electronic image stabilization (EIS). The OV8858, when paired with OmniVision's latest 2-megapixel sensors, can provide full resolution ViV snapshot images at 15 fps and preview ViV video at 30 fps.

The OV8858 fits into an  $8.5 \times 8.5$  mm camera module with a build height of approximately 4 mm.

Find out more at www.ovt.com.





### **Applications**

- Cellular Phones
- Tablets

#### PC Multimedia

## **Product Features**

- PureCel<sup>™</sup> image sensor
- 1.12 µm x 1.12 µm pixel with ViV<sup>™</sup> technology
- optical size of 1/4"
- 32.9° CRA for ~4mm Z-height
- programmable controls for frame rate, mirror and flip, cropping, and windowing
- supports images sizes:
  8MP (4:3 3264x2448),
  8MP (16:9 3264x1836),
  EIS 1080p (2112x1188),
  1080p (1920x1080),
  EIS 2012 (2102 70) EIS 720p (1408x792), and more
- 8MP at 30 fps
- two-wire serial bus control (SCCB)
- frame exposure mode for still image (with mechanical shutter)
- 4k bits of embedded one-time programmable (OTP) memory for customer use

- supports Video-in-Video (ViV) mode using an on-chip 1-lane MIPI receiver and a secondary sensor
- special ViV features include: ViV video at up to 30 fps, ViV snapshot at up to 15 fps, arbitrary positions and shapes for ViV window, separate AWB compensation for secondary sensor, and more
- two on-chip phase lock loops (PLLs)
- image quality control: defect pixel correction, automatic black level calibration, lens shading correction
- alternate row HDR
- built-in temperature sensor
- suitable for module size of 8.5 mm x 8.5 mm x -4 mm

OV08858-G04A-Z (color, chip probing, 200 µm backgrinding, reconstructed wafer with good die)

# **Product Specifications**

- active array size: 3264 x 2448
- power supply: - analog: 2.6 to 3.0V (2.8V nominal) - core: 1.14 to 1.26V (1.2V nominal) - I/O: 1.7 to 3.0V (1.8V or 2.8V nominal)
- power requirements:
  active: 153 mW
  standby: 160 µW - XSHUTDOWN: 0.3 µW
- temperature range:
  operating: -30°C to +85°C junction temperature stable image: 0°C to +60°C junction temperature
- output formats: up to
- 4-lane MIPI serial output
- output formats: 10-bit RAW RGB data

input clock frequency: 6 - 27 MHz maximum image transfer rate: 3264x2448: 30 fps - 3264x1836: 30 fps

■ lens chief ray angle: 32.9° non-linear

OV8858

- 2112x1184: 60 fps - 1920x1080: 60 fps

lens size: 1/4"

- 1408x792: 90 fps
- scan mode: progressive
- **pixel size:** 1.12 μm x 1.12 μm
- 🔳 image area: 3678.3 μm x 2767.68 μm
- package/die dimensions:
  COB: 5040 μm x 4590 μm
  RW: 5090 μm x 4640 μm

# Functional Block Diagram





Version 1.5, December, 2014